

## N-Channel Enhancement Mode Power MOSFET

<p><b>Description</b></p> <p>The G120N03D3 uses advanced trench technology to provide excellent <math>R_{DS(ON)}</math>, low gate charge. It can be used in a wide variety of applications.</p> <p><b>General Features</b></p> <ul style="list-style-type: none"> <li>● <math>V_{DS}</math> 30V</li> <li>● <math>I_D</math> (at <math>V_{GS} = 10V</math>) 28A</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = 10V</math>) &lt; 10mΩ</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = 4.5V</math>) &lt; 15mΩ</li> <li>● 100% Avalanche Tested</li> <li>● RoHS Compliant</li> </ul> <p><b>Application</b></p> <ul style="list-style-type: none"> <li>● Power switch</li> <li>● DC/DC converters</li> </ul>	<p>Schematic diagram</p> <p>pin assignment</p> <p>DFN3X3-8L</p>
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<b>Ordering Information</b>			
<b>Device</b>	<b>Package</b>	<b>Marking</b>	<b>Packaging</b>
G120N03D3	DFN3X3-8L	G120N03	5000pcs/Reel

<b>Absolute Maximum Ratings</b> $T_C = 25^\circ\text{C}$ , unless otherwise noted			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Drain-Source Voltage	$V_{DS}$	30	V
Continuous Drain Current	$I_D$	28	A
Pulsed Drain Current (note1)	$I_{DM}$	112	A
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Power Dissipation	$P_D$	20	W
Single pulse avalanche energy (note2)	$E_{AS}$	25	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 To 150	°C

<b>Thermal Resistance</b>			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	50	°C/W
Maximum Junction-to-Case	$R_{thJC}$	6.25	°C/W

**Specifications**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	30	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{DS} = 30\text{V}, V_{GS} = 0\text{V}$	--	--	1	$\mu\text{A}$
Gate-Source Leakage	$I_{\text{GSS}}$	$V_{GS} = \pm 20\text{V}$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.0	1.7	2.5	V
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10\text{V}, I_D = 10\text{A}$	--	6.7	10	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 10\text{A}$	--	10	15	
Forward Transconductance	$g_{\text{FS}}$	$V_{GS} = 5\text{V}, I_D = 10\text{A}$	--	28	--	S
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{GS} = 0\text{V}, V_{DS} = 15\text{V}, f = 1.0\text{MHz}$	--	1077	--	$\text{pF}$
Output Capacitance	$C_{\text{oss}}$		--	123	--	
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	106	--	
Total Gate Charge	$Q_g$	$V_{DD} = 15\text{V}, I_D = 10\text{A}, V_{GS} = 10\text{V}$	--	18	--	$\text{nC}$
Gate-Source Charge	$Q_{gs}$		--	3	--	
Gate-Drain Charge	$Q_{gd}$		--	4	--	
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{DD} = 15\text{V}, I_D = 10\text{A}, R_G = 3\Omega$	--	5	--	$\text{ns}$
Turn-on Rise Time	$t_r$		--	13	--	
Turn-off Delay Time	$t_{d(\text{off})}$		--	21	--	
Turn-off Fall Time	$t_f$		--	7	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$	$T_C = 25^\circ\text{C}$	--	--	28	A
Body Diode Voltage	$V_{SD}$	$T_J = 25^\circ\text{C}, I_{SD} = 10\text{A}, V_{GS} = 0\text{V}$	--	--	1.2	V
Reverse Recovery Charge	$Q_{rr}$	$I_F = 10\text{A}, V_{GS} = 0\text{V}$ $dI/dt = 100\text{A}/\mu\text{s}$	--	11	--	$\text{nC}$
Reverse Recovery Time	$T_{rr}$		--	21	--	ns

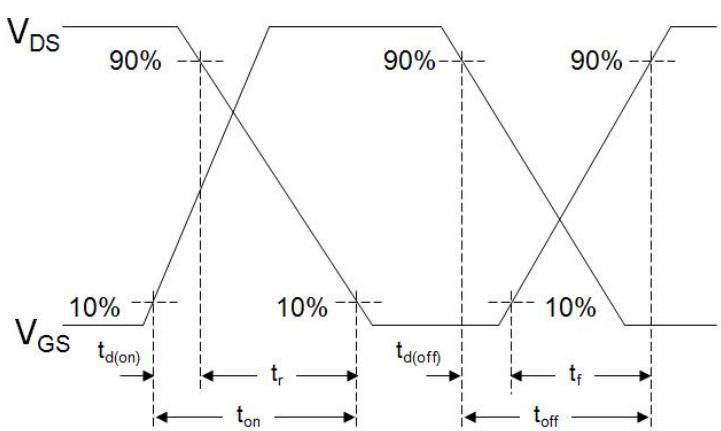
**Notes**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. EAS condition :  $T_J=25^\circ\text{C}$ ,  $V_{DD}=30\text{V}$ ,  $V_{GS}=10\text{V}$ ,  $L=0.5\text{mH}$ ,  $R_G=25\Omega$
3. Identical low side and high side switch with identical  $R_G$

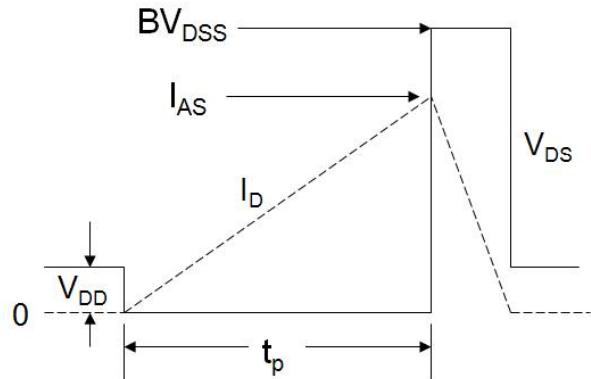
### Gate Charge Test Circuit



### Switch Time Test Circuit

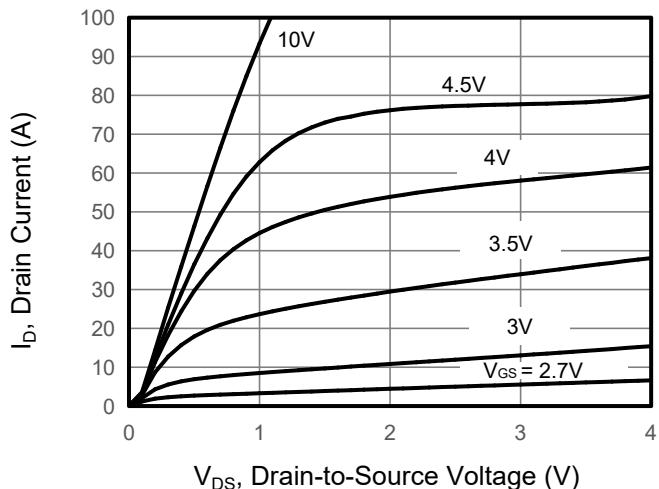


### EAS Test Circuit

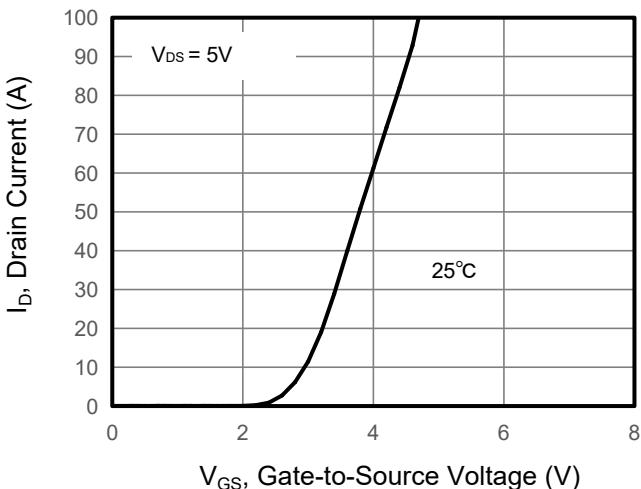


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

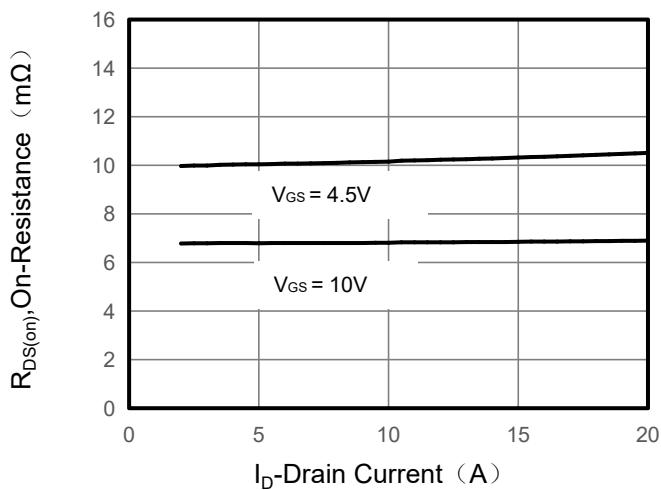
**Figure 1. Output Characteristics**



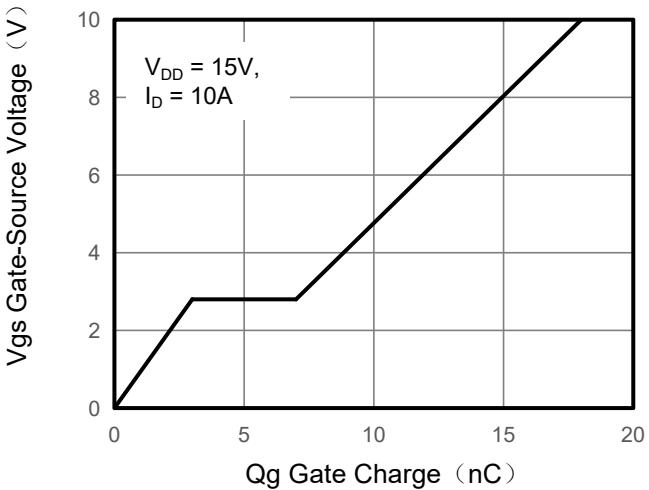
**Figure 2. Transfer Characteristics**



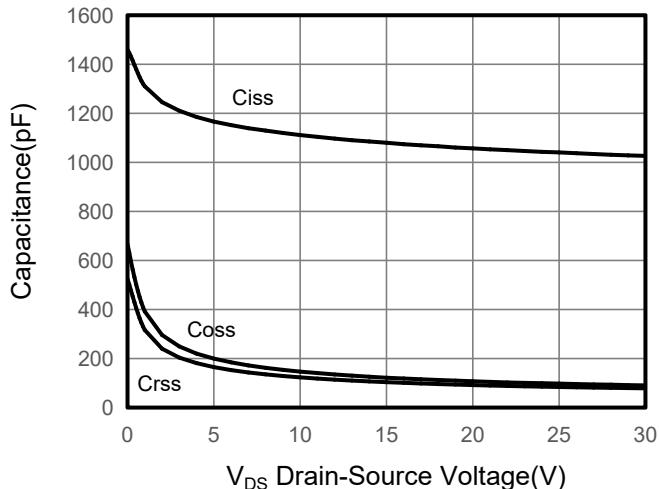
**Figure 3. Drain Source On Resistance**



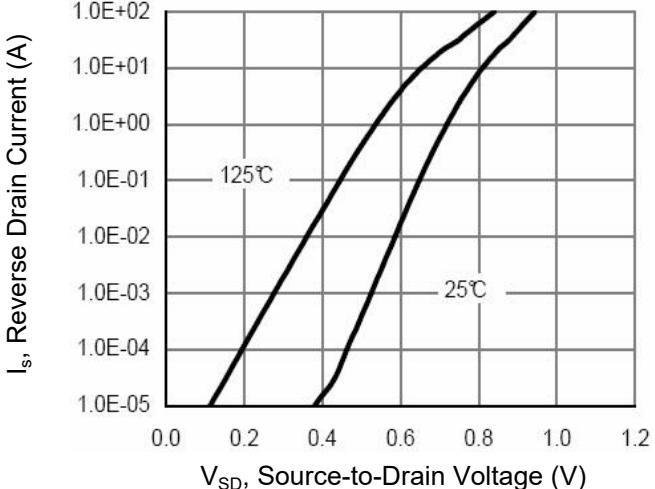
**Figure 4. Gate Charge**



**Figure 5. Capacitance**

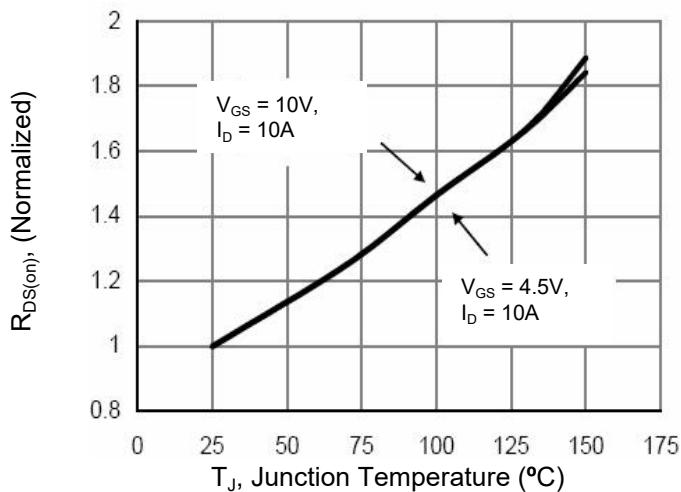


**Figure 6. Source-Drain Diode Forward**

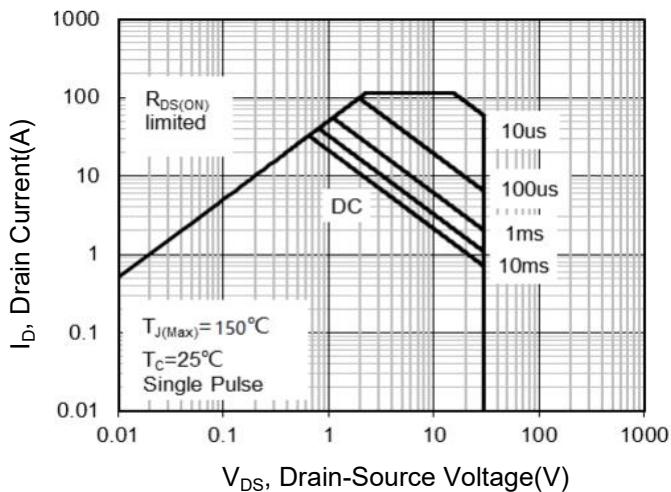


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

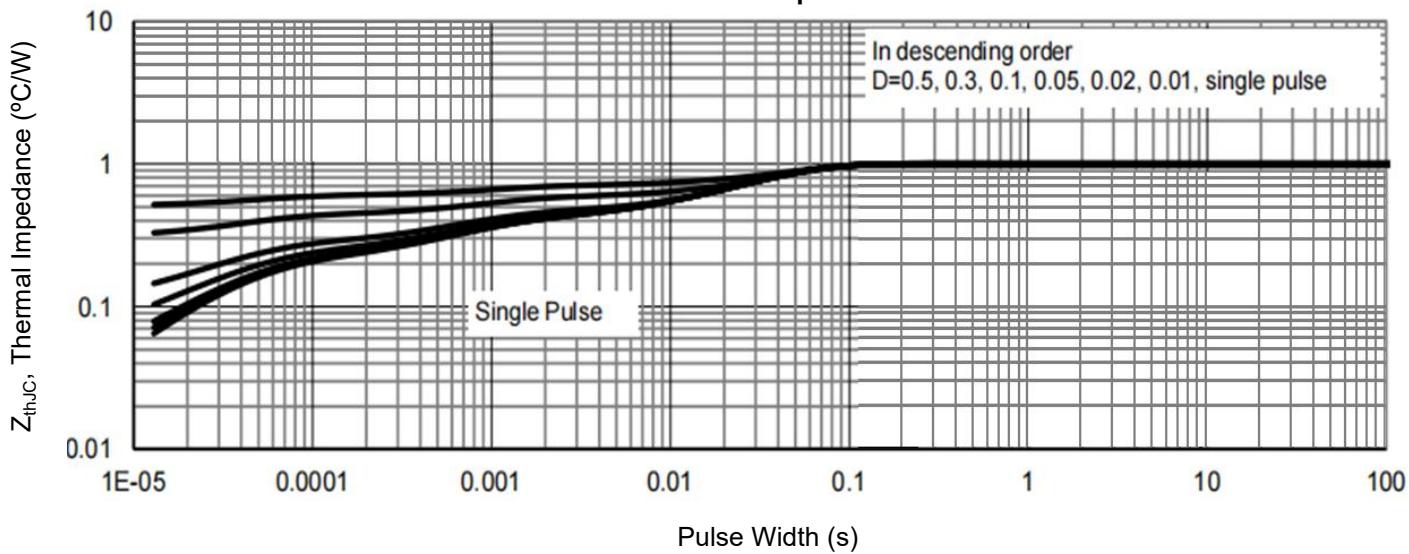
**Figure 7. Drain-Source On-Resistance**



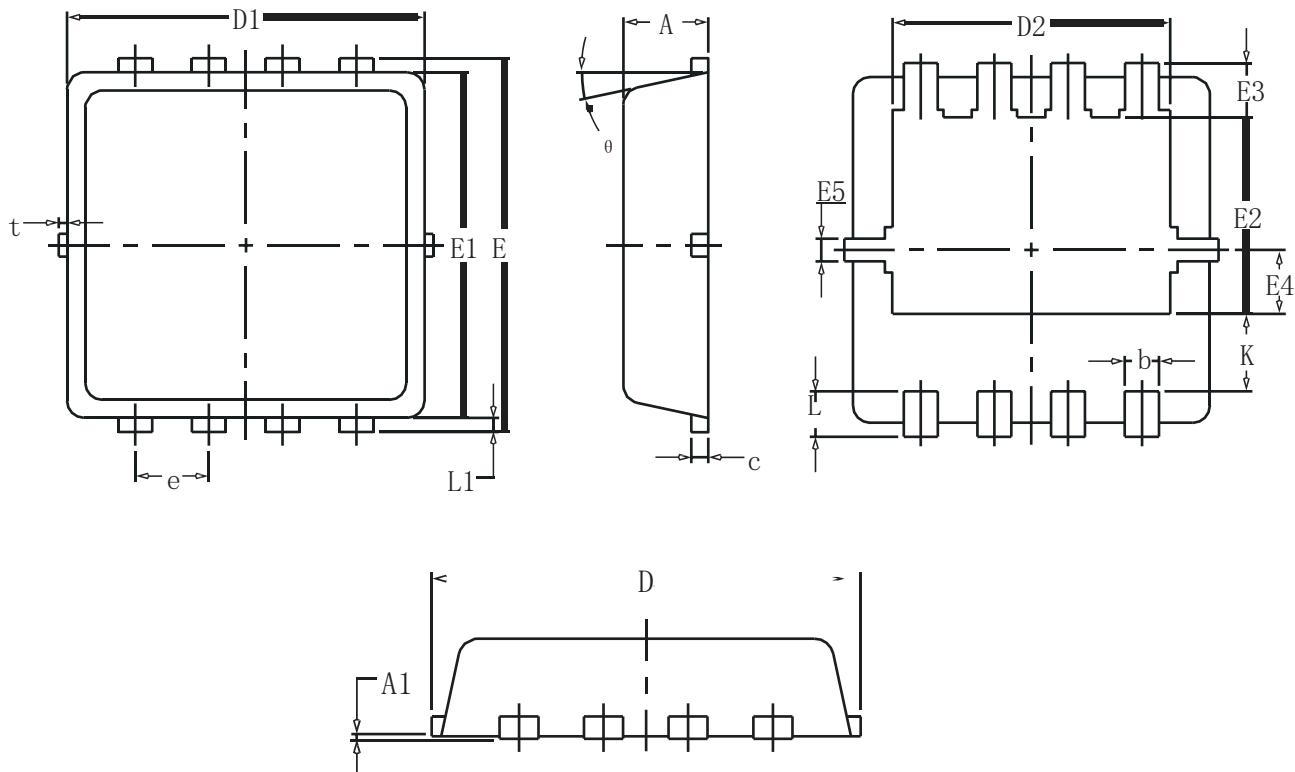
**Figure 8. Safe Operation Area**



**Figure 9. Normalized Maximum Transient Thermal Impedance**



## DFN3\*3-8L Package Information



SYMBOL	COMMON		
	MIN	NOM	MAX
A	0.70	0.75	0.85
A1	-	-	0.05
b	0.20	0.30	0.40
c	0.10	0.152	0.25
D	3.15	3.30	3.45
D1	3.00	3.15	3.25
D2	2.29	2.45	2.65
E	3.15	3.30	3.45
E1	2.90	3.05	3.20
E2	1.54	1.74	1.94
E3	0.28	0.48	0.65
E4	0.37	0.57	0.77
E5	0.10	0.20	0.30
e	0.60	0.65	0.70
K	0.59	0.69	0.89
L	0.30	0.40	0.50
L1	0.06	0.125	0.20
t	0	0.075	0.13
θ	10°	12°	14°